

NOTES:

ELECTRICAL:

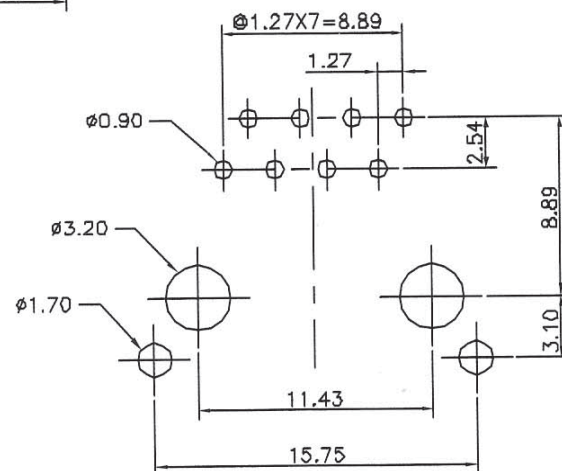
1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
3. PLATING : 1: CONTACT AREA- SELECTIVE GOLD PLATING.
2: TAILS- 150µ" TIN-LEAD MIN OVER 50µ" NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
 2. OPERATION: 0°C TO 70°C.
- MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 6B, SUBPART F.
CUL FILE NO. E163191



PC Board Layout Component Side Shown

DATA SHEET

Description: RJ45 Top entry Modular Jack
Tin plated shield, 6µ" gold

Part-no. SPEED: --
Project-no. SPEED: N-IN20Ja
Data sheet-no.: DBLKS1326
Index: 0
Date: 09.04.2004

Part-no. customer: --
Project-no. customer: --
Designed: Frank Hesseler
Checked: *M. H.*
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